

1.2A High Output Current LDO Regulator

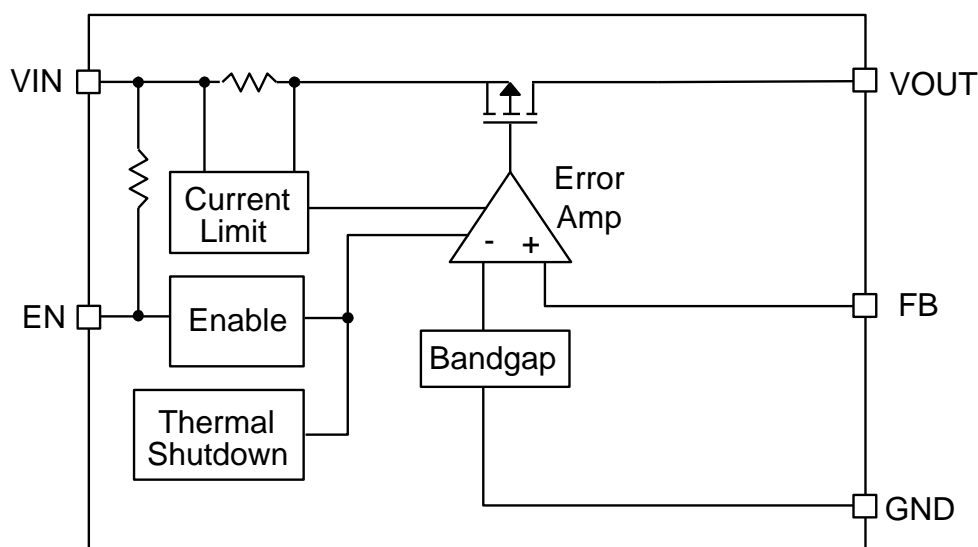
❖ GENERAL DESCRIPTION

The AX6631 is a low noise, high output current, low quiescent current and low dropout linear regulator. The Device includes pass element, error amplifier, band-gap, current limit and thermal shutdown circuitry. The output current is up to 1.2A, the characteristics of low dropout voltage and less quiescent current make it good for some critical current application, and for example, some battery powered devices. The typical quiescent current is approximately 50 μ A. In the shutdown mode, the maximum supply current is less than 1 μ A. Built-in current-limit, Short current protection and thermal-shutdown functions prevent any fault condition from IC damage.

❖ FEATURES

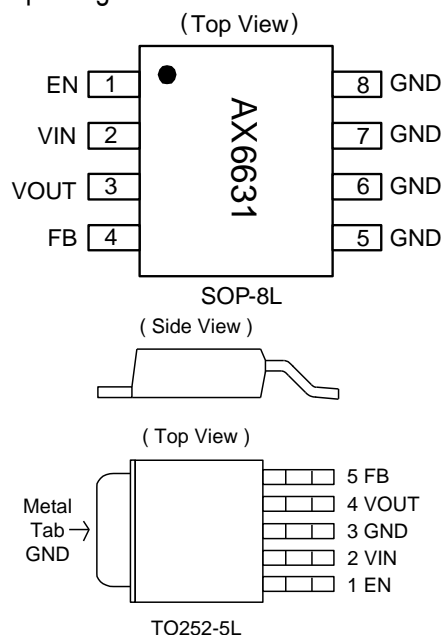
- Input voltage range : 2.6V~5.5V
- Adjustable Output voltage form 0.8V to 5.0V
- Dropout voltage is 380mV at 1A output current
- Guaranteed 1.2A output current
- Low quiescent current is 50 μ A (typ.)
- Maximum supply current in shutdown mode <1 μ A
- Fast transient response
- Current limit and thermal shutdown protection
- Short circuit current fold-back
- Available in the SOP-8L and TO252-5L Pb-Free Packages

❖ BLOCK DIAGRAM



❖ PIN ASSIGNMENT

The packages of AX6631 are SOP-8L and TO252-5L; the pin assignment is given by:



Name	Description
EN	Active-Low Shutdown Input. A logic low reduces the supply current to less than 1μA. Connect to V_{IN} or Floating for normal operation.
VIN	Input voltage
GND	Ground
VOUT	Regulator Output Voltage. Adjustable from 0.8V to 5.5V.
FB	Feedback Input for Setting the Output Voltage. Connect to an external resistor divider for adjustable output operation.

❖ ORDER/MARKING INFORMATION

Order Information	Top Marking
<p>AX6631 XX X</p> <pre> graph TD AX6631_XX_X[AX6631 XX X] --> Package AX6631_XX_X --> Packing Package --> S[S : SOP-8L] Package --> D5[D5 : TO252-5L] Packing --> Blank[Blank: Bulk] Packing --> A[A : Taping] </pre> <p>Package S : SOP-8L D5 : TO252-5L</p> <p>Packing Blank: Bulk A : Taping</p>	<p>Logo ← AX 6 6 3 1 → Part number Y Y W W X → ID code: internal WW: 01~52 Year: 10=2010 11=2011</p>

❖ ABSOLUTE MAXIMUM RATINGS (at $T_A=25^{\circ}\text{C}$)

Characteristics	Symbol	Rating	Unit
V_{IN} Pin Voltage	V_{IN}	GND - 0.3 to GND + 6	V
Output Voltage	V_{OUT}	GND - 0.3 to $V_{IN} + 0.3$	V
EN Pin Voltage	V_{EN}	GND - 0.3 to + 6	V
FB Pin Voltage	V_{FB}	GND - 0.3 to + 6	V
Power Dissipation	PD	SOP8=1.65, TO252=2.22	W
Storage Temperature Range	T_{ST}	-40 to +150	$^{\circ}\text{C}$
Operating Temperature Range	T_{OP}	-40 to +85	$^{\circ}\text{C}$
Junction Temperature	T_J	-40 to +125	$^{\circ}\text{C}$
Thermal Resistance from Junction to case	θ_{JC}	SOP8=20, TO252=10	$^{\circ}\text{C/W}$
Thermal Resistance from Junction to ambient	θ_{JA}	SOP8=60, TO252=45	$^{\circ}\text{C/W}$

Note: θ_{JA} is measured with the PCB copper area of approximately 1 in²(Multi-layer). That need connect to GND/ Tap pin.

❖ ELECTRICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ (unless otherwise noted)

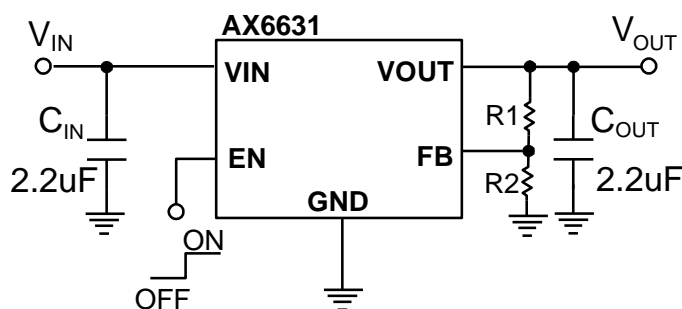
Characteristics	Symbol	Conditions	Min	Typ	Max	Units
Input Voltage	V_{IN}	(Note 1)	2.6	-	5.5	V
FB Voltage	V_{FB}	$V_{IN}=2.6\text{V}$ to 5.5V , $I_{OUT}=1\text{mA}$	0.784	0.8	0.816	V
FB Input Leakage Current	I_{FB}	$V_{FB}=0.8\text{V}$	-100	-	100	nA
Adjustable Output Voltage Range	V_{OUT}		V_{FB}	-	5.0	V
Quiescent Current	I_Q	$I_{OUT}=0\text{mA}$, $V_{IN}=5\text{V}$	-	50	-	μA
Shutdown Current	I_{SD}	$V_{IN}=3.6\text{V}$, $I_{OUT}=0\text{mA}$, $V_{EN}=0\text{V}$	-	-	1	μA
Dropout Voltage	V_{DROP}	$I_{OUT}=1.0\text{A}$	$V_{OUT}=1.50\text{V}$	-	1.10	V
			$V_{OUT}=1.80\text{V}$	-	0.8	
			$V_{OUT}=2.50\text{V}$	-	0.57	
			$V_{OUT}=3.30\text{V}$	-	0.38	
Current Limit (Note 2)	I_{LIMIT}		1.3	1.5	-	A
Short Circuit Current	I_{short}	$V_{FB}<0.3\text{V}$	-	300	-	mA
Load Regulation (Note 3)	ΔV_{LOAD}	$I_{OUT}=10\text{m}\sim 1.2\text{A}$	-	0.4	1	%
Ripple Rejection	PSRR	$C_{IN}=2.2\mu\text{F}$, $C_{OUT}=2.2\mu\text{F}$, $I_{OUT}=10\text{mA}$	$F=120\text{Hz}$	-	65	dB
			$F=1\text{KHz}$	-	55	
Enable Input Threshold	V_{ENH}	Regulator Enable	2.0	-	-	V
	V_{ENL}	Regulator Shutdown	-	-	0.6	
Enable Pin Current	I_{ENH}	$V_{EN}=V_{IN}$	-	0.003	0.1	μA
	I_{ENL}	$V_{IN}=3.6\text{V}$, $V_{EN}=0\text{V}$	-	0.35	1	
Temperature Shutdown	T_S		-	140	-	$^{\circ}\text{C}$
Temperature Shutdown Hysteresis	T_{SH}		-	30	-	$^{\circ}\text{C}$

Note 1: Minimum V_{IN} voltage is defined by output adds a dropout voltage.

Note 2: Current limit is measured at constant junction temperature by using pulsed testing with a low ON time.

Note 3: Regulation is measured at constant junction temperature by using pulsed testing with a low ON time.

❖ APPLICATION CIRCUIT



$$V_{OUT}=V_{FB}*(1+R1/R2)$$

$$V_{FB}=0.8\text{V}$$

$$R2 \text{ Range}=50\text{K}\sim 300\text{K}$$

❖ FUNCTION DESCRIPTIONS

A minimum of 2.2μF capacitor must be connected from V_{OUT} to ground to insure stability. Typically a large storage capacitor is connected from V_{IN} to ground to ensure that the input voltage does not sag below the minimum dropout voltage during the load transient response. This pin must always be dropout voltage higher than V_{OUT} in order for the device to regulate properly.

Enable Function

The AX6631 features an LDO regulator enable/disable function. To assure the LDO regulator will switch on; the EN turn on control level must be greater than 2.0 volts. The LDO regulator will go into the shutdown mode when the voltage on the EN pin falls below 0.6 volts. For to protecting the system, the AX6631 have a quick-discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

FB Function

The output is an adjustable version, the FB voltage is 0.8V. The output voltage can be set by outside resistances. The output voltage, V_{OUT}, is then given by the following equation:

$$V_{OUT} = 0.8 * (1 + R1/R2)$$

For the reasons of reducing power dissipation and loop stability, R2 is recommending to choose 50K~300KΩ.

❖ APPLICATION INFORMATION

Like any low-dropout regulator, the AX6631 requires input and output decoupling capacitors. The device is specifically designed for portable applications requiring minimum board space and smallest components. These capacitors must be correctly selected for good performance (see Capacitor Characteristics Section). Please note that linear regulators with a low dropout voltage have high internal loop gains which require care in guarding against oscillation caused by insufficient decoupling capacitance.

Capacitor Selection

Normally, use a 2.2μF capacitor on the input and a 2.2μF capacitor on the output of the AX6631. Larger input capacitor values and lower ESR (X5R, X7R) provide better supply-noise rejection and transient response. A higher- value output capacitor (4.7μF) may be necessary if large, fast transients are anticipated and the device is located several inches from the power source.

Input-Output (Dropout) Voltage

A regulator's minimum input-to-output voltage differential (dropout voltage) determines the lowest usable supply voltage. In battery-powered systems, this determines the useful end-of-life battery voltage. Because the device uses a PMOS, its dropout voltage is a function of drain-to source on-resistance, $R_{DS(ON)}$, multiplied by the load current:

$$V_{DROPOUT} = V_{IN} - V_{OUT} = R_{DS(ON)} \times I_{OUT}$$

Current Limit and Short-Circuit Protection

The AX6631 used a current sense-resistor to monitor the output current. A portion of the PMOS output transistor's current is mirrored to a resistor such that the voltage across this resistor is proportional to the output current. Once the output current exceeds limit threshold, AX6631 would be protected with a limited output current. Further more, when the output is short to ground, the output current would be folded-back to a less limit.

Thermal Considerations

The AX6631 series can deliver a current of up to 1.2A over the full operating junction temperature range. However, the maximum output current must be derated at higher ambient temperature to ensure the junction temperature does not exceed 125°C. With all possible conditions, the junction temperature must be within the range specified under operating conditions. Power dissipation can be calculated based on the output current and the voltage drop across regulator.

$$PD = (V_{IN} - V_{OUT}) I_{OUT}$$

The final operating junction temperature for any set of conditions can be estimated by the following thermal equation:

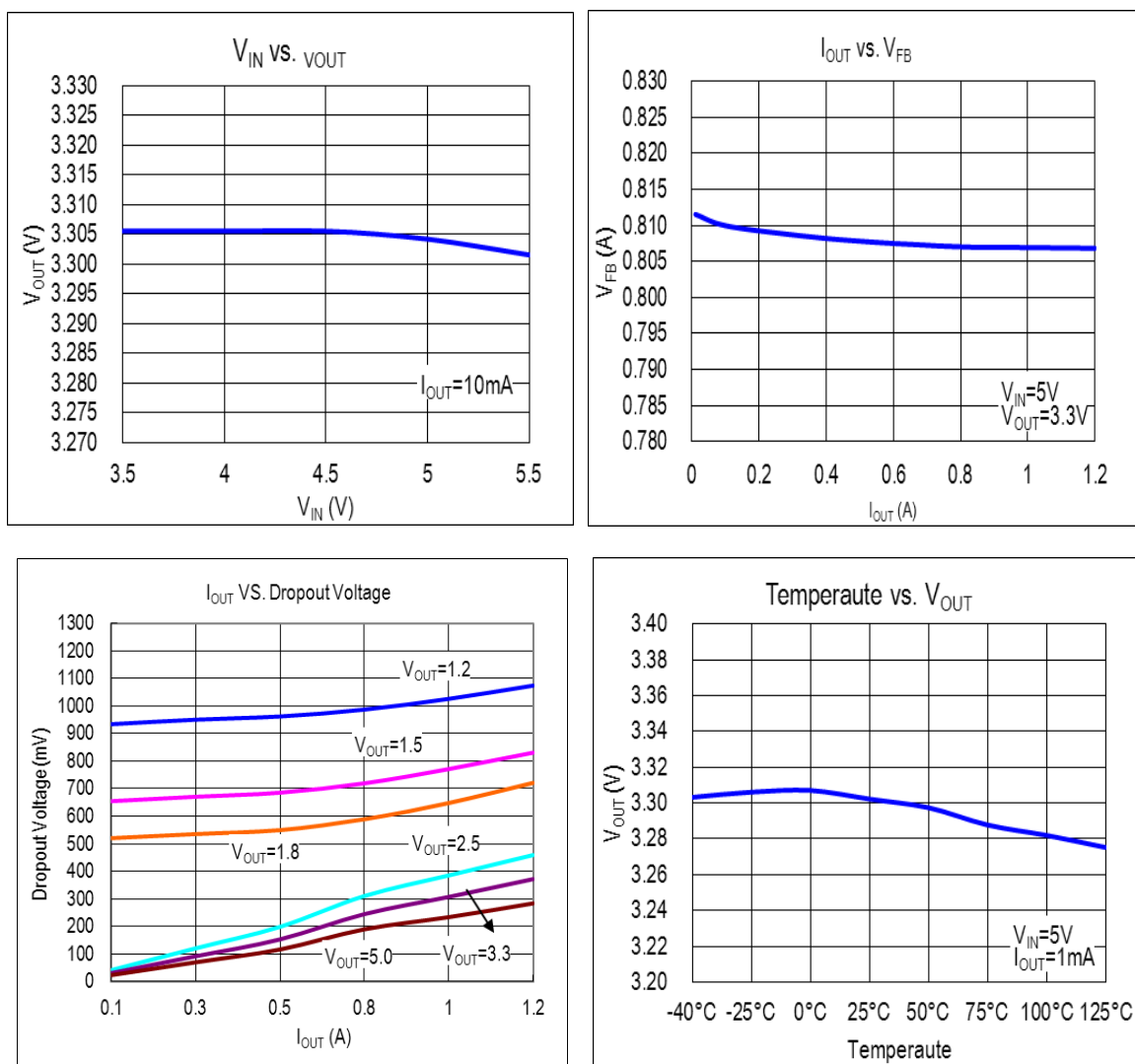
$$PD (MAX) = (T_{J(MAX)} - T_A) / \theta_{JA}$$

Where $T_{J(MAX)}$ is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA}) for SOP-8L package at recommended minimum footprint is 60°C/W. Visit our website in which "Recommended Footprints for Soldering Surface Mount Packages" for detail.

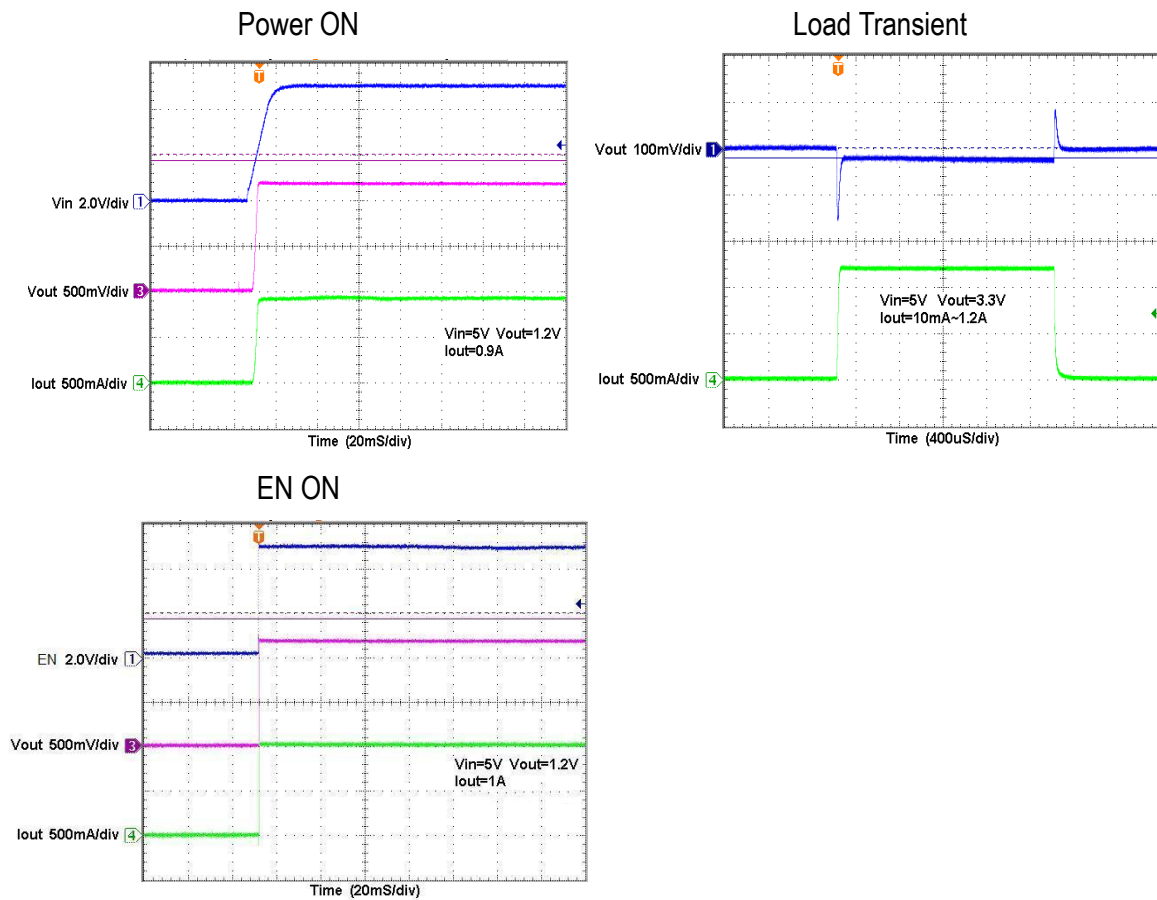
PCB Layout

An input capacitance of $\cong 2.2\mu\text{F}$ is required between the AX6631 input pin and ground (the amount of the capacitance may be increased without limit), this capacitor must be located a distance of not more than 1cm from the input and return to a clean analog ground. Input capacitor can filter out the input voltage spike caused by the surge current due to the inductive effect of the package pin and the printed circuit board's routing wire. Otherwise, the actual voltage at the VIN pin may exceed the absolute maximum rating. The output capacitor also must be located a distance of not more than 1cm from output to a clean analog ground. Because it can filter out the output spike caused by the surge current due to the inductive effect of the package pin and the printed circuit board's routing wire.

❖ TYPICAL CHARACTERISTICS

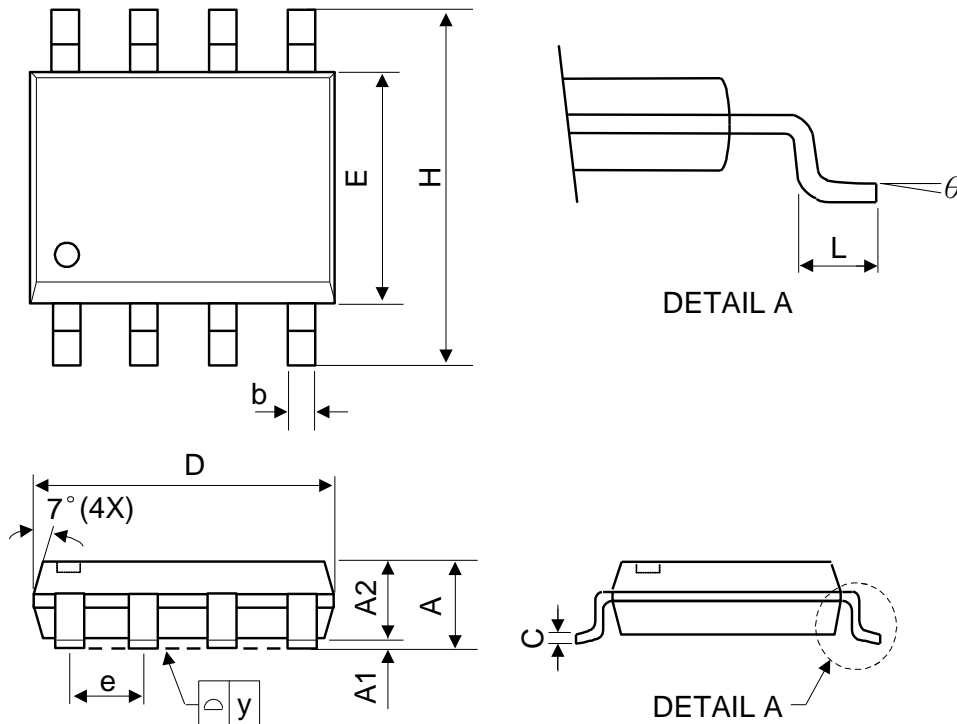


❖ TYPICAL CHARACTERISTICS (CONTINUOUS)



❖ **PACKAGE OUTLINES**

(1) **SOP-8L**

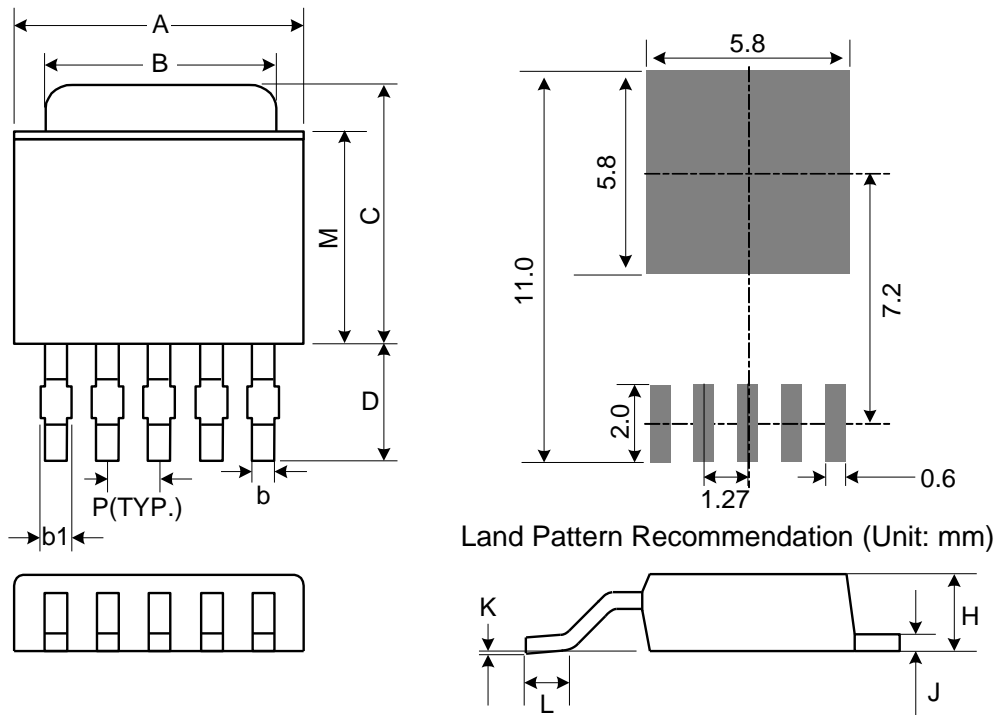


Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	1.75	-	-	0.069
A1	0.1	-	0.25	0.04	-	0.1
A2	1.25	-	-	0.049	-	-
C	0.1	0.2	0.25	0.0075	0.008	0.01
D	4.7	4.9	5.1	0.185	0.193	0.2
E	3.7	3.9	4.1	0.146	0.154	0.161
H	5.8	6	6.2	0.228	0.236	0.244
L	0.4	-	1.27	0.015	-	0.05
b	0.31	0.41	0.51	0.012	0.016	0.02
e	1.27 BSC			0.050 BSC		
y	-	-	0.1	-	-	0.004
θ	0°	-	8°	0°	-	8°

Mold flash shall not exceed 0.25mm per side

JEDEC outline: MS-012 AA

(2) T0252-5L



Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	6.35	6.6	6.73	0.250	0.260	0.265
B	5.21	5.33	5.46	0.205	0.210	0.215
C	6.86	7.24	7.62	0.270	0.285	0.300
D	2.67 REF			0.105 REF		
P	1.27 REF			0.050 REF		
H	2.18	2.29	2.39	0.086	0.090	0.094
J	0.46	0.51	0.58	0.018	0.020	0.023
K	0.00	0.08	0.13	0.000	0.003	0.005
L	1.40	1.60	1.78	0.055	0.063	0.070
M	5.33	5.46	5.59	0.210	0.215	0.220
b	0.38	0.56	0.71	0.015	0.022	0.028
b1	0.38	0.53	0.66	0.015	0.021	0.026

Mold flash shall not exceed 0.005inch per side